

/ Descriptions

WR0<50 P M M E S Q S æ M ç s ll 1

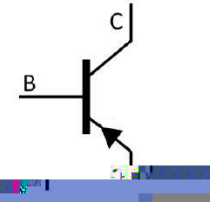
/ a05dc0Meatures

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/ aApplications 05dc0

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/ a05dc0Equivalent Circuit



/ 0 5 d c 0 Pinning



X

X

X

/ hFE Classifications & Marking

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BD034L

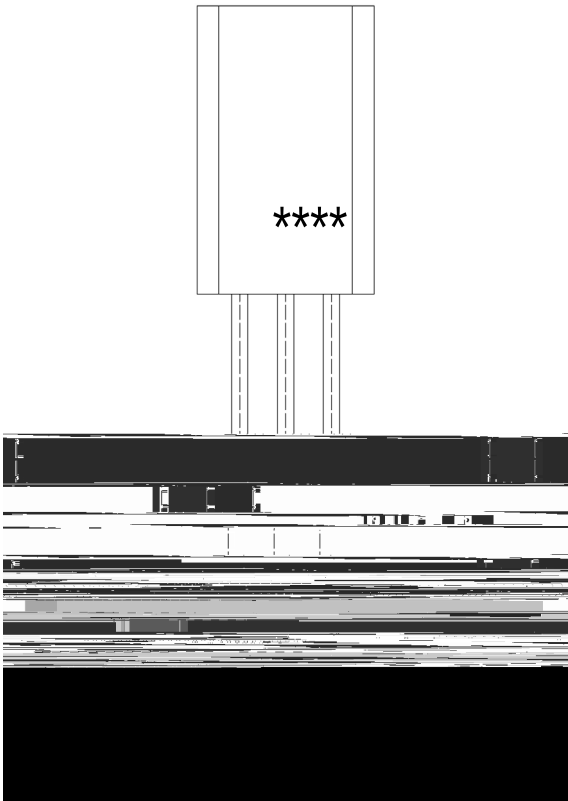
/ Package Dimensions

TO-92LM

Unit: mm

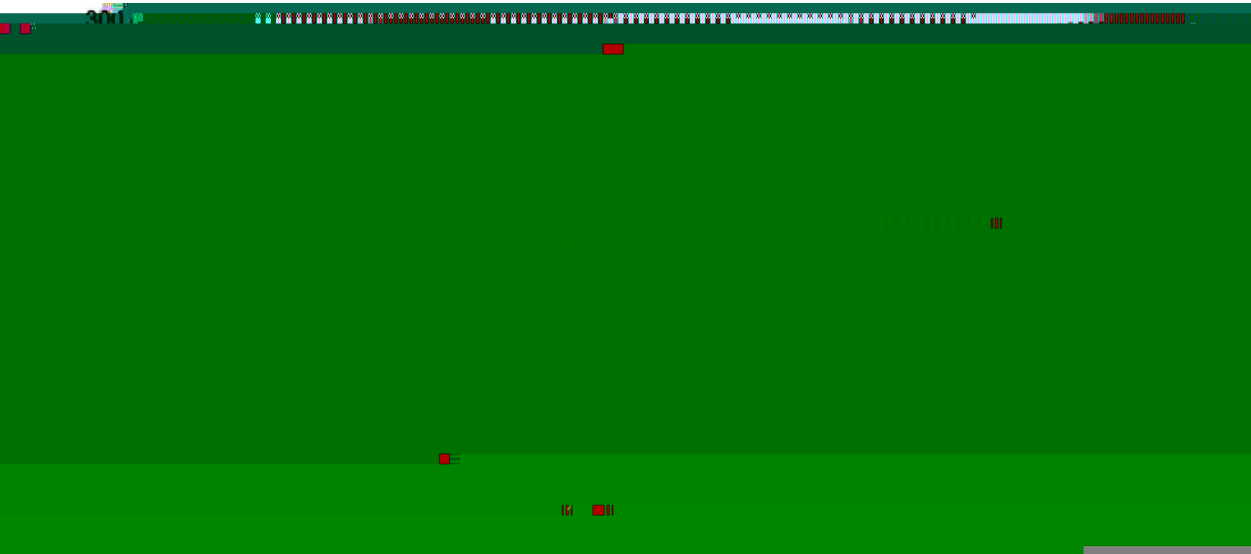


/ Marking Instructions



Б " X	
EU:	№ 3 " Пб
G3670 X	№ 3 " Пб
U:	№ k _И " 6 Пб
---- X	№ 1 F " Пб 1 F " Пб

() / Temperature Profile for Dip Soldering(Pb-Free)



1. The temperature profile for dip soldering is as follows:
The temperature of the soldering iron should be controlled within 260°C±10°C.
The temperature of the soldering iron should be controlled within 150°C±10°C.
The temperature of the soldering iron should be controlled within 100°C±10°C.

/ Resistance to Soldering Heat Test Conditions

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/ Packaging SPEC.

“Q T Y E

	Units/Bag	Bags/Inner Box	Units/Inner Box	
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